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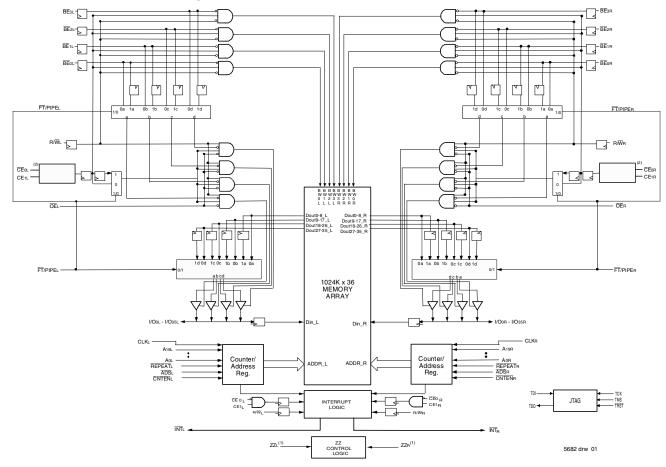


#### **HIGH-SPEED 2.5V** 1024K x 36 nt IDT70T3509M **SYNCHRONOUS DUAL-PORT STATIC RAM** WITH 3.3V OR 2.5V INTERFACE Features: - Data input, address, byte enable and control registers True Dual-Port memory cells which allow simultaneous - Self-timed write allows fast cycle time access of the same memory location Separate byte controls for multiplexed bus and bus ٠ High-speed data access matching compatibility - Commercial: 4.2ns (133MHz)(max.) Dual Cycle Deselect (DCD) for Pipelined Output Mode - Industrial: 4.2ns (133MHz)(max.) 2.5V (±100mV) power supply for core \* Selectable Pipelined or Flow-Through output mode LVTTL compatible, selectable 3.3V (±150mV) or 2.5V Counter enable and repeat features

- Interrupt Flags
- \* Full synchronous operation on both ports
  - 7.5ns cycle time, 133MHz operation (9.5Gbps bandwidth)
  - 1.5ns setup to clock and 0.5ns hold on all control, data, and address inputs @ 133MHz
  - Fast 4.2ns clock to data out

## **Functional Block Diagram**

- (±100mV) power supply for I/Os and control signals on each port
- ٠ Includes JTAG functionality
- Available in a 256-pin Ball Grid Array (BGA)
- Common BGA footprint provides design flexibility over seven density generations (512K to 36M-bit)
- ٠ Green parts available, see ordering information



- 1. The sleep mode pin shuts off all dynamic inputs, except JTAG inputs, when asserted. All static inputs, i.e., PL/FTx and OPTx and the sleep mode pins themselves (ZZx) are not affected during sleep mode.
- 2. See Truth Table I for Functionality.

## **Description:**

The IDT70T3509M is a high-speed 1024K x 36 bit synchronous Dual-Port RAM. The memory array utilizes Dual-Port memory cells to allow simultaneous access of any address from both ports. Registers on control, data, and address inputs provide minimal setup and hold times. The timing latitude provided by this approach allows systems to be designed with very short cycle times. With an input data register, the IDT70T3509M has been optimized for applications having unidirectional or bidirectional data flow in bursts. An automatic power down feature, controlled by  $\overline{CE}_0$  and  $CE_1$ , permits the on-chip circuitry of each port to enter a very low standby power mode.

The 70T3509M can support an operating voltage of either 3.3V or 2.5V on one or both ports, controllable by the OPT pins. The power supply for the core of the device (VDD) is at 2.5V.

08/03/04

## Pin Configuration (1,2,3,4)

### 70T3509M BP BP-256<sup>(5,7)</sup>

### 256-Pin BGA Top View<sup>(6)</sup>

| A1           | <sup>A2</sup>    | A3                   | A4            | A5            | A6            | A7          | A8            | A9            | A10                    | A11            | A12         | A13         | A14            | A15            | A16               |
|--------------|------------------|----------------------|---------------|---------------|---------------|-------------|---------------|---------------|------------------------|----------------|-------------|-------------|----------------|----------------|-------------------|
| NC           | TDI              | A19L                 | A17L          | A14L          | A11L          | A8L         | BE2L          | CE1L          | OEL                    | CNTENL         | <b>A</b> 5L | A2L         | A0L            | NC             | NC                |
| B1<br>I/O18L | <sup>B2</sup> NC | <sup>B3</sup><br>TDO | B4<br>A18L    | B5<br>A15L    | B6<br>A12L    | B7<br>A9L   | B8<br>BE3L    | B9<br>CE0L    | <sup>B10</sup><br>R/WL | B11<br>REPEATL | B12<br>A4L  | B13<br>A1L  | B14<br>VDD     | в15<br>I/O17L  | <sup>B16</sup> NC |
| C1           | C2               | C3                   | C4            | C5            | C6            | C7          | C8            | C9            | C10                    | C11            | C12         | C13         | C14            | C15            | C16               |
| I/O18R       | I/O19L           | Vss                  | A16L          | A13L          | A10L          | A7L         | BE1L          | BE0L          | CLK∟                   | ADSL           | A6L         | A3∟         | OPT∟           | I/O17R         | I/O16L            |
| D1           | d2               | d3                   | D4            | d5            | d6            | d7          | d8            | d9            | d10                    | d11            | d12         | D13         | D14            | D15            | D16               |
| I/O20R       | I/O19R           | I/O20l               | PIPE/FTL      | Vddql         | Vddql         | Vddqr       | Vddqr         | Vddql         | Vddql                  | Vddqr          | Vddqr       | Vdd         | I/O15R         | I/O15L         | I/O16R            |
| e1           | E2               | E3                   | e4            | e5            | e6            | e7          | E8            | E9            | E10                    | E11            | e12         | e13         | E14            | e15            | E16               |
| I/O21r       | I/O21L           | I/O22L               | Vddql         | Vdd           | Vdd           | INTl        | Vss           | Vss           | Vss                    | Vdd            | Vdd         | Vddqr       | I/O13L         | I/O14l         | I/O14R            |
| F1           | F2               | F3                   | f4            | F5            | F6            | F7          | F8            | <sup>F9</sup> | F10                    | F11            | F12         | f13         | F14            | F15            | F16               |
| I/O23L       | I/ <b>O</b> 22R  | I/ <b>O</b> 23R      | Vddql         | Vdd           | NC            | NC          | Vss           | Vss           | Vss                    | Vss            | Vdd         | Vddqr       | I/O12R         | I/O13R         | I/O12L            |
| G1           | G2               | G3                   | G4            | G5            | G6            | G7          | G8            | <sup>G9</sup> | G10                    | G11            | G12         | g13         | G14            | G15            | G16               |
| I/O24R       | I/O24L           | I/O25L               | Vddqr         | Vss           | Vss           | Vss         | Vss           | Vss           | Vss                    | Vss            | Vss         | Vddql       | I/O10L         | I/O11L         | I/O11R            |
| h1           | H2               | H3                   | h4            | H5            | H6            | H7          | H8            | H9            | H10                    | H11            | H12         | h13         | h14            | H15            | h16               |
| I/O26l       | I/O25R           | I/O26R               | Vddqr         | VSS           | Vss           | Vss         | Vss           | Vss           | Vss                    | Vss            | Vss         | Vddql       | I/O9r          | IO9∟           | I/O10R            |
| J1           | j2               | j3                   | j4            | J5            | <sup>J6</sup> | J7          | J8            | <sup>J9</sup> | J10                    | J11            | J12         | j13         | J14            | j15            | J16               |
| I/O27L       | I/O28R           | I/O27R               | Vddql         | ZZR           | Vss           | Vss         | Vss           | Vss           | Vss                    | Vss            | <b>ZZ</b> L | Vddqr       | I/O8R          | I/O7r          | I∕O8∟             |
| к1           | k2               | k3                   | k4            | K5            | K6            | K7          | K8            | к9            | K10                    | K11            | K12         | k13         | k14            | к15            | к16               |
| I/O29R       | I/ <b>O</b> 29L  | I/O28l               | Vddql         | Vss           | Vss           | Vss         | Vss           | Vss           | Vss                    | Vss            | Vss         | Vddqr       | I/O6r          | I/O6l          | I/O7L             |
| l1           | l2               | l3                   | l4            | l5            | L6            | L7          | L8            | L9            | L10                    | L11            | l12         | l13         | l14            | l15            | l16               |
| I/O30L       | I/O31R           | I/O30R               | Vddqr         | Vdd           | NC            | NC          | Vss           | Vss           | Vss                    | Vss            | Vdd         | Vddql       | I/O5l          | I/O4r          | I/O5R             |
| м1           | m2               | m3                   | <sup>M4</sup> | <sup>M5</sup> | M6            | M7          | <sup>M8</sup> | <sup>M9</sup> | M10                    | M11            | M12         | m13         | m14            | <sup>M15</sup> | <sup>M16</sup>    |
| I/O32R       | I/O32l           | I/O31l               | Vddqr         | Vdd           | Vdd           | ĪNTR        | Vss           | Vss           | Vss                    | VDD            | Vdd         | Vddql       | I/O3r          | I∕O3∟          | I/O4L             |
| N1           | N2               | n3                   | N4            | N5            | N6            | n7          | n8            | N9            | n10                    | N11            | n12         | N13         | n14            | n15            | <sup>N16</sup>    |
| I/O33L       | I/O34R           | I/O33r               | PIPE/FTR      | Vddqr         | Vddqr         | Vddql       | Vddql         | Vddqr         | Vddqr                  | Vddql          | Vddql       | Vdd         | I/O2l          | I/O1r          | I/O2R             |
| P1           | p2               | P3                   | P4            | P5            | P6            | P7          | P8            | <sup>P9</sup> | P10                    | <sup>P11</sup> | P12         | P13         | P14            | p15            | P16               |
| I/O35R       | I/O34L           | TMS                  | A16R          | A13R          | A10R          | <b>A</b> 7R | BE1R          | BE0R          | CLKR                   | ADSr           | <b>A</b> 6R | <b>A</b> 3R | I/Ool          | I/Oor          | I/O1L             |
| ri           | <sup>R2</sup>    | <sup>R3</sup>        | R4            | R5            | R6            | R7          | R8            | R9            | <sup>R10</sup>         | ri1            | R12         | R13         | <sup>R14</sup> | R15            | <sup>R16</sup>    |
| I/O35l       | NC               | TRST                 | A18R          | A15R          | A12R          | A9R         | BE3R          | CEor          | R/WR                   | Repeatr        | <b>A</b> 4R | <b>A</b> 1R | OPTr           | NC             | NC                |
| T1           | T2               | T3                   | T4            | T5            | т6            | t7          | t8            | <sup>T9</sup> | T10                    | t11            | T12         | T13         | T14            | T15            | <sup>т16</sup>    |
| NC           | TCK              | <b>A</b> 19R         | A17R          | <b>A</b> 14R  | <b>А</b> 11R  | A8r         | BE2r          | CE1R          | OEr                    | CNTENR         | <b>A</b> 5R | A2R         | Aor            | NC             | NC                |

#### 5682 drw 02d

- 1. All VDD pins must be connected to 2.5V power supply.
- 2. All VDDQ pins must be connected to appropriate power supply: 3.3V if OPT pin for that port is set to VDD (2.5V), and 2.5V if OPT pin for that port is set to Vss (0V).
- 3. All Vss pins must be connected to ground supply.
- 4. Package body is approximately 17mm x 17mm x 1.76mm, with 1.0mm ball-pitch.
- 5. This package code is used to reference the package diagram.
- 6. This text does not indicate orientation of the actual part-marking.
- 7. BP-256 package thickness is 1.76mm nominal. This is thicker than the BC-256 package (1.40mm nominal) used for the lower density IDT dual-port products.

## IDT70T3509M

#### High-Speed 2.5V 1024K x 36 Dual-Port Synchronous Static RAM

#### **Commercial Temperature Range**

### **Pin Names**

| Left Port       | Right Port         | Names  |  |  |  |
|-----------------|--------------------|--|--|--|--|
| CEOL, CE1L      | CEOR, CE1R         | Chip Enables (Input) <sup>(5)</sup>                  |  |  |  |
| R/WL            | R/WR               | Read/Write Enable (Input)                            |  |  |  |
| ŌĒL             | ŌĒr                | Output Enable (Input)                                |  |  |  |
| Aol - A19L      | AOR - A19R         | Address (Input)                                      |  |  |  |
| 1/Ool - 1/O35l  | I/O0r - I/O35r     | Data Input/Output                                    |  |  |  |
| CLKL            | CLKR               | Clock (Input)  |  |  |  |
| PL/FTL          | PL/FT <sub>R</sub> | Pipeline/Flow-Through (Input)                        |  |  |  |
| ADSL            | ADSR               | Address Strobe Enable (Input)                        |  |  |  |
| CNTENL CNTENR   |                    | Counter Enable (Input)                               |  |  |  |
| REPEATL REPEATR |                    | Counter Repeat <sup>(3)</sup> (Input)                |  |  |  |
| BEOL - BE3L     | BEOR - BE3R        | Byte Enables (9-bit bytes) (Input) <sup>(5)</sup>    |  |  |  |
| VDDQL           | Vddqr              | Power (I/O Bus) (3.3V or 2.5V) <sup>(1)</sup> (Input |  |  |  |
| OPTL            | OPTR               | Option for selecting VDDQX <sup>(1,2)</sup> (Input)  |  |  |  |
| ZZ1.            | ZZR                | Sleep Mode pin <sup>(4)</sup> (Input)                |  |  |  |
|                 | VDD                | Power (2.5V) <sup>(1)</sup> (Input)                  |  |  |  |
|                 | Vss                | Ground (0V) (Input)                                  |  |  |  |
|                 | TDI                | Test Data Input                                      |  |  |  |
|                 | TDO                | Test Data Output                                     |  |  |  |
|                 | ТСК                | Test Logic Clock (10MHz) (Input)                     |  |  |  |
|                 | TMS                | Test Mode Select (Input)                             |  |  |  |
| -               | TRST               | Reset (Initialize TAP Controller) (Input)            |  |  |  |
| ĪNTL            | ĪNTr               | Interrupt Flag (Output)                              |  |  |  |

NOTES:

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- 1. VDD, OPTx, and VDDQx must be set to appropriate operating levels prior to applying inputs on the I/Os and controls for that port.
- 2. OPTx selects the operating voltage levels for the I/Os and controls on that port. If OPTx is set to Vob (2.5V), then that port's I/Os and controls will operate at 3.3V levels and Vobox must be supplied at 3.3V. If OPTx is set to Vss (0V), then that port's I/Os and address controls will operate at 2.5V levels and Vobox must be supplied at 2.5V. The OPT pins are independent of one another—both ports can operate at 3.3V levels, both can operate at 2.5V levels, or either can operate at 3.3V with the other at 2.5V.

3. When REPEATx is asserted, the counter will reset to the last valid address loaded via ADSx.

4. The sleep mode pin shuts off all dynamic inputs, except JTAG inputs, when asserted. All static inputs, i.e., PL/FTx and OPTx and the sleep mode pins themselves (ZZx) are not affected during sleep mode. It is recommended that boundary scan not be operated during sleep mode.

 Chip Enables and Byte Enables are double buffered when PL/FT = VIH, i.e., the signals take two cycles to deselect.

|     | High-Speed 2.5V 1024K x 36 Dual-Port Synchronous Static RAM |             |      |                   |                 |      |      | Com  | Commercial Temperature Range |                    |                    |                   |                  |                             |
|-----|---|-------------|------|-------------------|-----------------|------|------|------|------------------------------|--------------------|--------------------|-------------------|------------------|-----------------------------|
| Tru | th T  | abl         | e I– | -Re               | ad/\            | Nrit | e ar | າd E | nab                          | le Co              | ntrol              | (1,2,3,4)         |                  |                             |
| ŌĒ  | CLK   | <u>CE</u> ₀ | CE1  | <mark>BE</mark> ₃ | BE <sub>2</sub> | BE1  | BE₀  | R/W  | z                            | Byte 3<br>I/O27-35 | Byte 2<br>I/O18-26 | Byte 1<br>I/O9-17 | Byte 0<br>I/O0-8 | MODE                        |
| Х   | $\uparrow$  | Н           | L    | Х                 | Х               | Х    | Х    | Х    | L                            | High-Z             | High-Z             | High-Z            | High-Z           | Deselected-Power Down       |
| Х   | $\uparrow$  | L           | L    | Х                 | Х               | Х    | Х    | Х    | Х                            | Active             | Active             | Active            | Active           | Not Allowed                 |
| Х   | $\uparrow$  | Н           | Н    | Х                 | Х               | Х    | Х    | Х    | Х                            | Active             | Active             | Active            | Active           | Not Allowed                 |
| Х   | $\uparrow$  | L           | Н    | Н                 | Н               | Н    | Н    | Х    | L                            | High-Z             | High-Z             | High-Z            | High-Z           | All Bytes Deselected        |
| Х   | $\uparrow$  | L           | Н    | Н                 | Н               | Н    | L    | L    | L                            | High-Z             | High-Z             | High-Z            | Din              | Write to Byte 0 Only        |
| Х   | $\uparrow$  | L           | Н    | Н                 | Н               | L    | Н    | L    | L                            | High-Z             | High-Z             | DIN               | High-Z           | Write to Byte 1 Only        |
| Х   | $\uparrow$  | L           | Н    | Н                 | L               | Н    | Н    | L    | L                            | High-Z             | Din                | High-Z            | High-Z           | Write to Byte 2 Only        |
| Х   | $\uparrow$  | L           | Н    | L                 | Н               | Н    | Н    | L    | L                            | Din                | High-Z             | High-Z            | High-Z           | Write to Byte 3 Only        |
| Х   | $\uparrow$  | L           | Н    | Н                 | Н               | L    | L    | L    | L                            | High-Z             | High-Z             | DIN               | Din              | Write to Lower 2 Bytes Only |
| Х   | $\uparrow$  | L           | Н    | L                 | L               | Н    | Н    | L    | L                            | Din                | Din                | High-Z            | High-Z           | Write to Upper 2 bytes Only |
| Х   | $\uparrow$  | L           | Н    | L                 | L               | L    | L    | L    | L                            | Din                | Din                | Din               | DIN              | Write to All Bytes          |
| L   | $\uparrow$  | L           | Н    | н                 | Н               | Н    | L    | Н    | L                            | High-Z             | High-Z             | High-Z            | Dout             | Read Byte 0 Only            |
| L   | $\uparrow$  | L           | Н    | н                 | Н               | L    | Н    | Н    | L                            | High-Z             | High-Z             | Dout              | High-Z           | Read Byte 1 Only            |
| L   | $\uparrow$  | L           | Н    | н                 | L               | Н    | Н    | Н    | L                            | High-Z             | Dout               | High-Z            | High-Z           | Read Byte 2 Only            |
| L   | $\uparrow$  | L           | Н    | L                 | Н               | Н    | Н    | Н    | L                            | Dout               | High-Z             | High-Z            | High-Z           | Read Byte 3 Only            |
| L   | $\uparrow$  | L           | Н    | Н                 | Н               | L    | L    | Н    | L                            | High-Z             | High-Z             | Dout              | Dout             | Read Lower 2 Bytes Only     |
| L   | $\uparrow$  | L           | Н    | L                 | L               | Н    | Н    | Н    | L                            | Dout               | Dout               | High-Z            | High-Z           | Read Upper 2 Bytes Only     |
| L   | $\uparrow$  | L           | Н    | L                 | L               | L    | L    | Н    | L                            | Dout               | Dout               | Dout              | Dout             | Read All Bytes              |
| Н   | $\uparrow$  | Х           | Х    | Х                 | Х               | Х    | Х    | Х    | L                            | High-Z             | High-Z             | High-Z            | High-Z           | Outputs Disabled            |
| Х   | Х   | Х           | Х    | Х                 | Х               | Х    | Х    | Х    | Н                            | High-Z             | High-Z             | High-Z            | High-Z           | Sleep Mode                  |

#### NOTES:

IDT70T3509M

1. "H" = VIH, "L" = VIL, "X" = Don't Care.

2.  $\overline{\text{ADS}}$ ,  $\overline{\text{CNTEN}}$ ,  $\overline{\text{REPEAT}} = X$ .

3.  $\overline{\text{OE}}$  and ZZ are asynchronous input signals.

4. It is possible to read or write any combination of bytes during a given access. A few representative samples have been illustrated here.

## Truth Table II—Address Counter Control <sup>(1,2)</sup>

| Address | Previous<br>Internal<br>Address | Internal<br>Address<br>Used | CLK        | ADS              | CNTEN            | REPEAT <sup>(6)</sup> | I/O <sup>(3)</sup> | MODE   |
|---------|---------------------------------|-----------------------------|------------|------------------|------------------|-----------------------|--------------------|--|
| An      | Х                               | An                          | <b>↑</b>   | L <sup>(4)</sup> | х                | Н                     | Dı⁄o (n)           | External Address Used                                      |
| Х       | An                              | An + 1                      | $\uparrow$ | Н                | L <sup>(5)</sup> | Н                     | Di/o(n+1)          | Counter Enabled—Internal Address generation <sup>(7)</sup> |
| х       | An + 1                          | An + 1                      | Ŷ          | Н                | н                | Н                     | Di/0(n+1)          | External Address Blocked—Counter disabled (An + 1 reused)  |
| Х       | Х                               | An                          | $\uparrow$ | Х                | х                | L <sup>(4)</sup>      | Di/o(n)            | Counter Set to last valid ADS load                         |
|         |                                 |                             |            |                  |                  |                       |                    | 5682 tbl 03  |

5682 tbl 02

#### NOTES:

1. "H" = VIH, "L" = VIL, "X" = Don't Care.

2. Read and write operations are controlled by the appropriate setting of R/W, CEo, CE1, BEn and OE.

3. Outputs configured in flow-through output mode: if outputs are in pipelined mode the data out will be delayed by one cycle.

4. ADS and REPEAT are independent of all other memory control signals including CEo, CE1 and BEn

5. The address counter advances if CNTEN = VIL on the rising edge of CLK, regardless of all other memory control signals including CE0, CE1, BEn.

6. When REPEAT is asserted, the counter will reset to the last valid address loaded via ADS. This value is not set at power-up: a known location should be loaded via ADS during initialization if desired. Any subsequent ADS access during operations will update the REPEAT address location.

7. Address A19 must be managed as part of a full depth counter implementation using the IDT70T3509M. For physical addresses 00000H through 7FFFFH the value of a A19 is 0, while for physical addresses 80000H through FFFFFH the value of A19 is 1. The user needs to keep track of the device counter and make sure that A19 is actively driven from 0-to-1 or 1-to-0 and held as needed at the appropriate address boundaries for full depth counter operation and that A19 is in the appropriate state when using the REPEAT function.

## Recommended Operating Temperature and Supply Voltage (1)

| Grade      | Ambient<br>Temperature | GND | Vdd                 |
|------------|------------------------|-----|---------------------|
| Commercial | 0°C to +70°C           | 0V  | 2.5V <u>+</u> 100mV |
| Industrial | -40°C to +85°C         | 0V  | 2.5V <u>+</u> 100mV |
| NOTES      |                        |     | 5682 tbl 04         |

NOTES:

1. This is the parameter TA. This is the "instant on" case temperature.

## Recommended DC Operating Conditions with VDDQ at 2.5V

| Symbol | Parameter   | Min.                | Тур. | Max.                        | Unit |
|--------|---|---------------------|------|-----------------------------|------|
| Vdd    | Core Supply Voltage   | 2.4                 | 2.5  | 2.6                         | V    |
| VDDQ   | I/O Supply Voltage <sup>(3)</sup>   | 2.4                 | 2.5  | 2.6                         | V    |
| Vss    | Ground  | 0                   | 0    | 0                           | V    |
| Vін    | Input High Volltage<br>(Address, Control &<br>Data I/O Inputs) <sup>(3)</sup> | 1.7                 |      | Vddq + 100mV <sup>(2)</sup> | v    |
| Vін    | Input High Voltage -<br>JTAG  | 1.7                 |      | Vdd + 100mV <sup>(2)</sup>  | V    |
| Vін    | Input High Voltage -<br>ZZ, OPT, PIPE/FT                                      | VDD - 0.2V          |      | Vdd + 100mV <sup>(2)</sup>  | v    |
| Vı∟    | Input Low Voltage   | -0.3 <sup>(1)</sup> |      | 0.7                         | V    |
| V⊫     | Input Low Voltage -<br>ZZ, OPT, PIPE/FT                                       | -0.3 <sup>(1)</sup> |      | 0.2                         | V    |

NOTES:

5682 tbl 05a

5682 tbl 05b

1. VIL (min.) = -1.0V for pulse width less than tcyc/2 or 5ns, whichever is less.

2. VIH (max.) = VDDQ + 1.0V for pulse width less than tcyc/2 or 5ns, whichever is less.

3. To select operation at 2.5V levels on the I/Os and controls of a given port, the OPT pin for that port must be set to  $V_{ss}(0V)$ , and  $V_{DDOX}$  for that port must be supplied as indicated above.

## Recommended DC Operating Conditions with VDDQ at 3.3V

| Symbol | Parameter   | Min.                  | Тур. | Max.                       | Unit |  |  |  |
|--------|---|-----------------------|------|----------------------------|------|--|--|--|
| VDD    | Core Supply Voltage   | 2.4                   | 2.5  | 2.6                        | V    |  |  |  |
| Vddq   | I/O Supply Voltage <sup>(3)</sup>   | 3.15                  | 3.3  | 3.45                       | V    |  |  |  |
| Vss    | Ground  | 0                     | 0    | 0                          | V    |  |  |  |
| Vін    | Input High Voltage<br>(Address, Control<br>&Data I/O Inputs) <sup>(3)</sup> | ddress, Control 2.0 — |      |                            | V    |  |  |  |
| Vін    | Input High Voltage -<br>JTAG  | 1.7                   |      | VDD + 100mV <sup>(2)</sup> | v    |  |  |  |
| Vін    | Input High Voltage -<br>ZZ, OPT, PIPE/FT                                    | VDD - 0.2V            |      | $V_{DD}$ + 100m $V^{(2)}$  | v    |  |  |  |
| Vi∟    | Input Low Voltage   | -0.3 <sup>(1)</sup>   |      | 0.8                        | V    |  |  |  |
| VIL    | Input Low Voltage -<br>ZZ, OPT, PIPE/FT                                     | -0.3 <sup>(1)</sup>   |      | 0.2                        | v    |  |  |  |

NOTES:

1. VIL (min.) = -1.0V for pulse width less than tcyc/2, or 5ns, whichever is less.

2. VIH (max.) = VDDQ + 1.0V for pulse width less than tcyc/2 or 5ns, whichever is less.

 To select operation at 3.3V levels on the I/Os and controls of a given port, the OPT pin for that port must be set to VDD (2.5V), and VDDQX for that port must be supplied as indicated above.

## Absolute Maximum Ratings (1)

| Symbol                                     | Rating  | Com'l<br>& Ind     | Unit |  |  |  |  |
|--|---|--------------------|------|--|--|--|--|
| Vterm<br>(Vdd)                             | VDD Terminal Voltage<br>with Respect to GND           | -0.5 to 3.6        | V    |  |  |  |  |
| Vterm <sup>(2)</sup><br>(Vddq)             | VDDQ Terminal Voltage<br>with Respect to GND          | -0.3 to VDDQ + 0.3 | V    |  |  |  |  |
| VTERM <sup>(2)</sup><br>(INPUTS and I/O's) | Input and I/O Terminal<br>Voltage with Respect to GND | -0.3 to VDDQ + 0.3 | V    |  |  |  |  |
| TBIAS <sup>(3)</sup>                       | Temperature Under Bias                                | -55 to +125        | °C   |  |  |  |  |
| Тята                                       | Storage Temperature                                   | -65 to +150        | °C   |  |  |  |  |
| Tjn  | Junction Temperature                                  | +150               | °C   |  |  |  |  |
| IOUT(For VDDQ = 3.3V)                      | л(For VDDQ = 3.3V) DC Output Current                  |                    | mA   |  |  |  |  |
| IOUT(For VDDQ = 2.5V)                      | DC Output Current                                     | 40                 | mA   |  |  |  |  |
| 5682 tbl 06                                |   |                    |      |  |  |  |  |

#### NOTES:

- Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
- This is a steady-state DC parameter that applies after the power supply has reached its nominal operating value. Power sequencing is not necessary; however, the voltage on any Input or I/O pin cannot exceed VDDO during power supply ramp up.
- 3. Ambient Temperature under DC Bias. No AC Conditions. Chip Deselected.

## Capacitance<sup>(1)</sup>

## (TA = +25°C, F = 1.0MHz) BGA ONLY

| Symbol              | Parameter          | Conditions | Max. | Unit        |
|---------------------|--------------------|------------|------|-------------|
| CIN                 | Input Capacitance  | VIN = OV   | 35   | pF          |
| COUT <sup>(2)</sup> | Output Capacitance | Vout = 0V  | 35   | pF          |
|                     |                    |            |      | 5682 tbl 07 |

#### NOTES:

 These parameters are determined by device characterization, but are not production tested.

2. COUT also references CI/O.

## DC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range (VDD = 2.5V ± 100mV)

|            |  |  | 70T3509MS |      |      |
|------------|--|--|-----------|------|------|
| Symbol     | Parameter  | Test Conditions  | Min.      | Мах. | Unit |
| llul       | Input Leakage Current <sup>(1)</sup>             | VDDQ = Max., $V$ IN = 0 $V$ to $V$ DDQ                   | _         | 20   | μA   |
| llul       | JTAG & ZZ Input Leakage Current <sup>(1,2)</sup> | VDD = Max., VIN = 0V to VDD                              | -         | 60   | μA   |
| lllol      | Output Leakage Current <sup>(1,3)</sup>          | $\overline{CE}_0$ = VIH and CE1 = VIL, VOUT = 0V to VDDQ |           | 20   | μA   |
| Vol (3.3V) | Output Low Voltage <sup>(1)</sup>                | IOL = +4mA, VDDQ = Min.                                  |           | 0.4  | V    |
| Vон (3.3V) | Output High Voltage <sup>(1)</sup>               | Юн = -4mA, VDDQ = Min.                                   | 2.4       |      | V    |
| Vol (2.5V) | Output Low Voltage <sup>(1)</sup>                | IOL = +2mA, VDDQ = Min.                                  | _         | 0.4  | V    |
| Voн (2.5V) | Output High Voltage <sup>(1)</sup>               | IOH = -2mA, VDDQ = Min.                                  | 2.0       |      | V    |

#### NOTES:

1. VDDQ is selectable (3.3V/2.5V) via OPT pins. Refer to p.5 for details.

2. Applicable only for TMS, TDI and TRST inputs.

3. Outputs tested in tri-state mode.

5682 tbl 08

## DC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range <sup>(3)</sup> (VDD = 2.5V ± 100mV)

| -                                  |   |   |        |     | 70T3509<br>Co<br>& I | m'l  |            |
|------------------------------------|---|---|--------|-----|----------------------|------|------------|
| Symbol                             | Parameter   | Test Condition  | Versio | on  | Typ. <sup>(4)</sup>  | Мах. | Unit       |
| IDD                                | Dynamic Operating   | $\overline{CE}_{L}$ and $\overline{CE}_{R=}$ VIL,   | COM'L  | S   | 800                  | 1120 |            |
|                                    |   | Outputs Disabled,<br>f = fMAX <sup>(1)</sup>  | IND    | S   | 800                  | 1370 | mA         |
| ISB1 <sup>(6)</sup>                | Standby Current   | $\overline{CEL} = \overline{CER} = VIH$   | COM'L  | S   | 560                  | 760  |            |
| (Both Ports - TTL<br>Level Inputs) | $f = fMAX^{(1)}$  | IND   | S      | 560 | 940                  | mA   |            |
| ISB2 <sup>(6)</sup>                | ISB2 <sup>(6)</sup> Standby Current<br>(One Port - TTL<br>Level Inputs) | $\overline{CE}^{"}A^{"} = VIL and \overline{CE}^{"}B^{"} = VIH^{(5)}$   | COM'L  | S   | 680                  | 880  | mA         |
|                                    |   | Active Port Outputs Disabled,<br>f=fMAX <sup>(1)</sup>  | IND    | S   | 680                  | 1090 | ma         |
| ISB3                               | Full Standby Current<br>(Both Ports - CMOS                              | Both Ports $\overline{CE}_{0L} = \overline{CE}_{0R} \ge VDDQ - 0.2V$ and  | COM'L  | S   | 20                   | 60   | mA         |
|                                    | Level Inputs)   | $\begin{array}{l} \mbox{CE1L} = \mbox{CE1R} \leq 0.2V, \\ \mbox{VIN} \geq \mbox{VDDQ} \mbox{ - } 0.2V \mbox{ or VIN} \leq 0.2V, \mbox{ f} = \mbox{0}^{(2)} \end{array}$ | IND    | S   | 20                   | 80   | ma         |
| ISB4 <sup>(6)</sup>                | Full Standby Current<br>(One Port - CMOS                                | $\overline{CE}^{"}A^{"} \leq 0.2V$ and $\overline{CE}^{"}B^{"} \geq VDDQ - 0.2V^{(5)}$  | COM'L  | S   | 680                  | 880  | mA         |
|                                    | Level Inputs)   | $VIN \ge VDDQ - 0.2V$ or $VIN \le 0.2V$<br>Active Port, Outputs Disabled, f = fMAX <sup>(1)</sup>   | IND    | S   | 680                  | 1090 | ma         |
| lzz                                | Sleep Mode Current  | ZZL = ZZR = VIH<br>f=fMAX <sup>(1)</sup>  | COM'L  | S   | 20                   | 60   |            |
|                                    | (Both Ports - TTL<br>Level Inputs)                                      |   | IND    | S   | 20                   | 80   | mA         |
|                                    |   |   |        |     |                      | 56   | 682 tbl 09 |

#### NOTES:

1. At f = fMAX, address and control lines (except Output Enable) are cycling at the maximum frequency clock cycle of 1/tcrvc, using "AC TEST CONDITIONS".

2. f = 0 means no address, clock, or control lines change. Applies only to input at CMOS level standby.

- 3. Port "A" may be either left or right port. Port "B" is the opposite from port "A".
- 4. VDD = 2.5V, TA =  $25^{\circ}C$  for Typ, and are not production tested. IDD Dc(f=0) = 30mA (Typ).
- 5.  $\overline{CEx} = VIL$  means  $\overline{CEox} = VIL$  and CE1x = VIH (enabled)
- $\overline{CEx} = VIH$  means  $\overline{CE}_{0X} = VIH$  and  $CE_{1X} = VIL$  (disabled)

 $\overline{CEx} \le 0.2V$  means  $\overline{CE}_{0x} \le 0.2V$  and  $CE_{1x} \ge V_{DDQ} - 0.2V$  (enabled - CMOS levels)

 $\overline{CEx} \ge VDDQ - 0.2V$  means  $\overline{CE}_{0X} \ge VDDQ - 0.2V$  and  $CE_{1X} \le 0.2V$  (disabled - CMOS levels)

"X" represents "L" for left port or "R" for right port.

6. ISB1, ISB2 and ISB4 will all reach full standby levels (ISB3) on the appropriate port(s) if ZZL and/or ZZR = VIH.

IDT70T3509M High-Speed 2.5V 1024K x 36 Dual-Port Synchronous Static RAM

## AC Test Conditions (VDDQ - 3.3V/2.5V)

| Input Pulse Levels (Address & Controls) | GND to 3.0V/GND to 2.4V |  |  |  |
|---|-------------------------|--|--|--|
| Input Pulse Levels (I/Os)               | GND to 3.0V/GND to 2.4V |  |  |  |
| Input Rise/Fall Times                   | 2ns                     |  |  |  |
| Input Timing Reference Levels           | 1.5V/1.25V              |  |  |  |
| Output Reference Levels                 | 1.5V/1.25V              |  |  |  |
| Output Load                             | Figure 1                |  |  |  |

5682 tbl 10

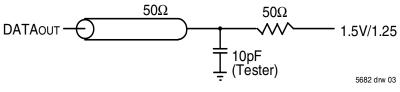
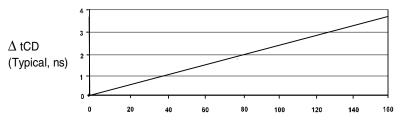


Figure 1. AC Output Test load.



 $\Delta$  Capacitance (pF) from AC Test Load 5682 drw 04

High-Speed 2.5V 1024K x 36 Dual-Port Synchronous Static RAM

#### 70T3509MS133 Com'l & Ind Symbol Parameter Min. Мах. Unit Clock Cycle Time (Flow-Through)<sup>(1)</sup> 25 tCYC1 ns tCYC2 Clock Cycle Time (Pipelined)<sup>(1)</sup> 7.5 ns Clock High Time (Flow-Through)(1) tCH1 10 ns Clock Low Time (Flow-Through)(1) 10 tCI 1 ns tCH2 Clock High Time (Pipelined)(2) 3 ns tCL2 Clock Low Time (Pipelined)(1) з ns tsa Address Setup Time 1.8 ns tHA Address Hold Time 0.5 ns tsc Chip Enable Setup Time 1.8 ns Chip Enable Hold Time 0.5 tHC ns Byte Enable Setup Time 1.8 tsB ns tнв Byte Enable Hold Time 0.5 ns tsw R/W Setup Time 1.8 ns R/W Hold Time tHW 0.5 ns tsp Input Data Setup Time 1.8 ns tHD Input Data Hold Time 0.5 ns tsad ADS Setup Time 1.8 ns **t**HAD ADS Hold Time 0.5 ns CNTEN Setup Time 1.8 tscn ns **t**HCN **CNTEN** Hold Time 0.5 ns REPEAT Setup Time **t**SRPT 1.8 ns 0.5 REPEAT Hold Time THRPT ns Output Enable to Data Valid 4.6 tOF ns tolz(4) Output Enable to Output Low-Z 1 ns tonz<sup>(4)</sup> Output Enable to Output High-Z 1 4.2 ns Clock to Data Valid (Flow-Through)(1) tCD1 15 ns Clock to Data Valid (Pipelined)(1) 4.2 tCD2 ns tDC Data Output Hold After Clock High 1 ns tCKHZ<sup>(4)</sup> Clock High to Output High-Z 1 4.2 ns tCKLZ<sup>(4)</sup> Clock High to Output Low-Z 1 ns Interrupt Flag Set Time 7 tins ns tinr Interrupt Flag Reset Time 7 ns tCOLS Collision Flag Set Time 4.2 ns Collision Flag Reset Time 4.2 **t**COLR ns tzzsc Sleep Mode Set Cycles 2 cycles з tzzbc Sleep Mode Recovery Cycles cycles Port-to-Port Delay Clock-to-Clock Offset tco 6 ns 5682 tbl 11

# AC Electrical Characteristics Over the Operating Temperature Range (Read and Write Cycle Timing) (2,3) (VDD = 2.5V ± 100mV, TA = 0°C to +70°C)

NOTES:

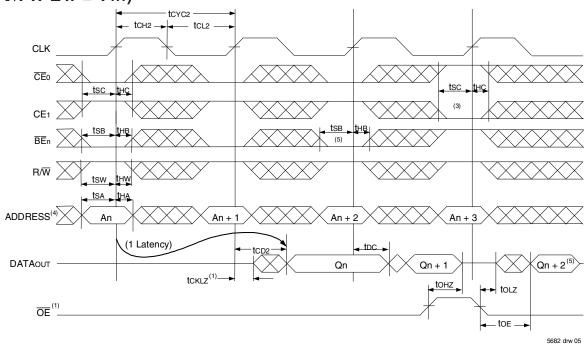
1. The Pipelined output parameters (tcvc2, tcD2) apply to either or both left and right ports when FT/PIPEx = VDD (2.5V). Flow-through parameters (tcvc1, tcD1) apply when FT/PIPE = Vss (0V) for that port.

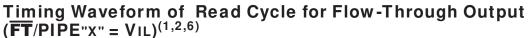
2. All input signals are synchronous with respect to the clock except for the asynchronous Output Enable (OE), FT/PIPE and OPT. FT/PIPE and OPT should be treated as DC signals, i.e. steady state during operation.

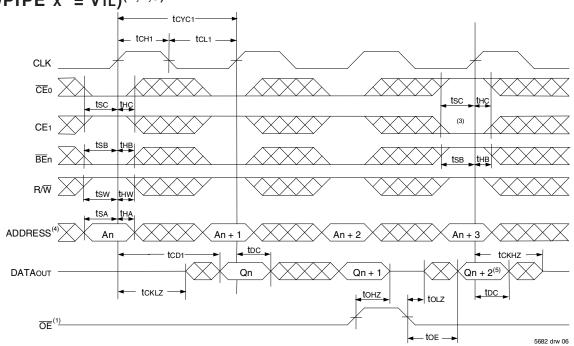
3. These values are valid for either level of VDDQ (3.3V/2.5V). See page 6 for details on selecting the desired operating voltage levels for each port.

4. Guaranteed by design (not production tested).

# Timing Waveform of Read Cycle for Pipelined Operation $(FT/PIPE'x' = VIH)^{(1,2)}$

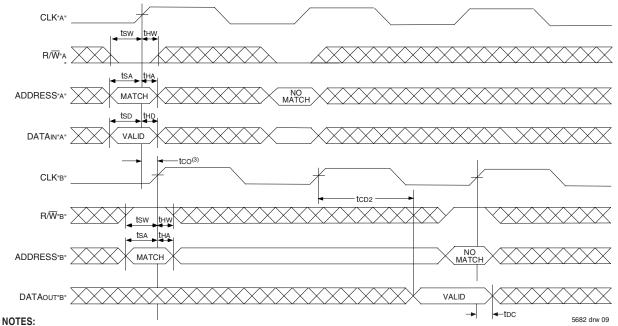






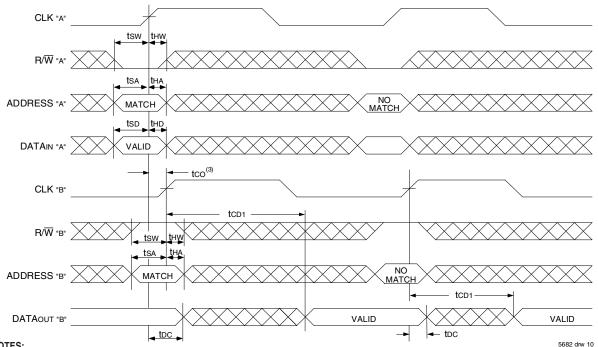
- 1. OE is asynchronously controlled; all other inputs depicted in the above waveforms are synchronous to the rising clock edge.
- 2.  $\overline{ADS} = VIL$ ,  $\overline{CNTEN}$  and  $\overline{REPEAT} = VIH$ .
- 3. The output is disabled (High-Impedance state) by  $\overline{CE}_0 = V_{IH}$ ,  $CE_1 = V_{IL}$ ,  $\overline{BE}_n = V_{IH}$  following the next rising edge of the clock. Refer to Truth Table 1.
- Addresses do not have to be accessed sequentially since ADS = VIL constantly loads the address on the rising edge of the CLK; numbers are for reference use only.
- 5. If BEn was HIGH, then the appropriate Byte of DATAOUT for Qn + 2 would be disabled (High-Impedance state).
- 6. "x" denotes Left or Right port. The diagram is with respect to that port.

Timing Waveform of Left Port Write to Pipelined Right Port Read<sup>(1,2,4)</sup>



- 1.  $\overline{CE}_{0}$ ,  $\overline{BE}_{n}$ , and  $\overline{ADS} = VIL$ ;  $CE_{1}$ ,  $\overline{CNTEN}$ , and  $\overline{REPEAT} = VIH$ .
- 2.  $\overline{OE} = V_{IL}$  for Port "B", which is being read from.  $\overline{OE} = V_{IH}$  for Port "A", which is being written to.
- If tco ≤ minimum specified, then data from Port "B" read is not valid until following Port "B" clock cycle (ie, time from write to valid read on opposite port will be tco + 2 tcyc2 + tcp2). If tco > minimum, then data from Port "B" read is available on first Port "B" clock cycle (ie, time from write to valid read on opposite port will be tco + tcyc2 + tcp2).
- 4. All timing is the same for Left and Right ports. Port "A" may be either Left or Right port. Port "B" is the opposite of Port "A"

## Timing Waveform with Port-to-Port Flow-Through Read<sup>(1,2,4)</sup>



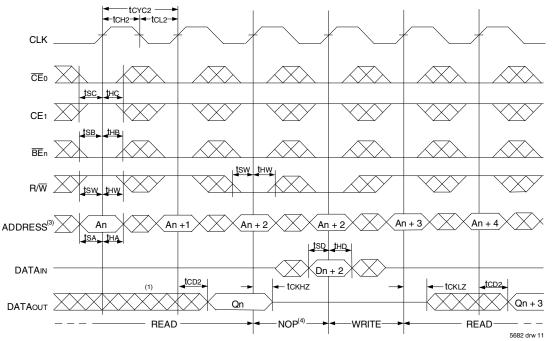
#### NOTES:

1.  $\overline{CE}_{0}$ ,  $\overline{BE}_{n}$ , and  $\overline{ADS} = V_{IL}$ ;  $CE_{1}$ ,  $\overline{CNTEN}$ , and  $\overline{REPEAT} = V_{IH}$ .

2.  $\overline{OE} = V_{IL}$  for the Right Port, which is being read from.  $\overline{OE} = V_{IH}$  for the Left Port, which is being written to.

- If tco ≤ minimum specified, then data from Port "B" read is not valid until following Port "B" clock cycle (i.e., time from write to valid read on opposite port will be tco + tcyc + tcp1). If tco > minimum, then data from Port "B" read is available on first Port "B" clock cycle (i.e., time from write to valid read on opposite port will be tco + tcp1).
- 4. All timing is the same for both left and right ports. Port "A" may be either left or right port. Port "B" is the opposite of Port "A".

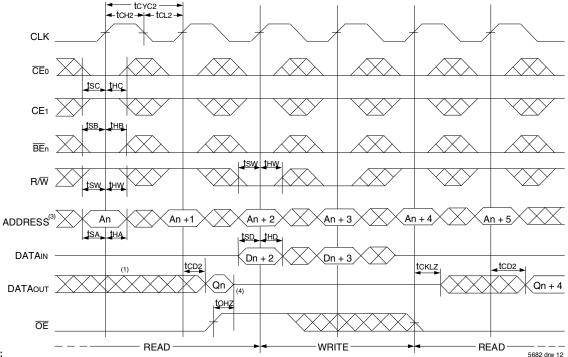
Timing Waveform of Pipelined Read-to-Write-to-Read ( $\overline{OE} = VIL$ )<sup>(2)</sup>



#### NOTES:

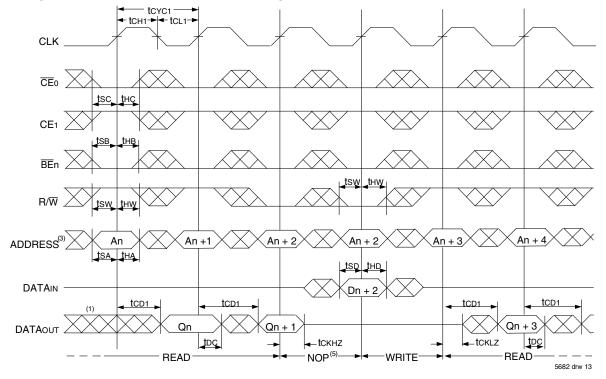
- 1. Output state (High, Low, or High-impedance) is determined by the previous cycle control signals.
- 2. CEo, BEn, and ADS = VIL; CE1, CNTEN, and REPEAT = VIH. "NOP" is "No Operation".
- 3. Addresses do not have to be accessed sequentially since ADS = VIL constantly loads the address on the rising edge of the CLK; numbers are for reference use only.
- 4. "NOP" is "No Operation." Data in memory at the selected address may be corrupted and should be re-written to guarantee data integrity.

## Timing Waveform of Pipelined Read-to-Write-to-Read (**OE** Controlled)<sup>(2)</sup>

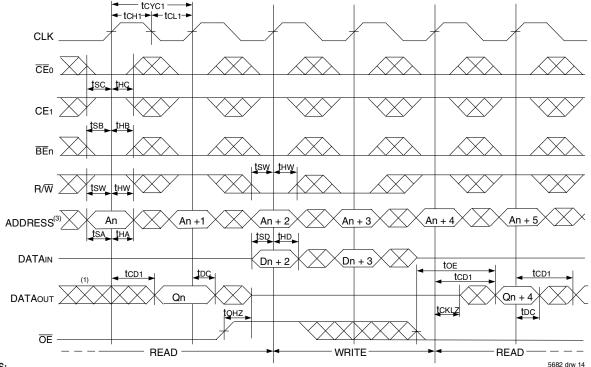


- 1. Output state (High, Low, or High-impedance) is determined by the previous cycle control signals.
- 2.  $\overline{CE}_0$ ,  $\overline{BE}_n$ , and  $\overline{ADS} = VIL$ ; CE1,  $\overline{CNTEN}$ , and  $\overline{REPEAT} = VIH$ .
- 3. Addresses do not have to be accessed sequentially since ADS = VIL constantly loads the address on the rising edge of the CLK; numbers are for reference use only.
- 4. This timing does not meet requirements for fastest speed grade. This waveform indicates how logically it could be done if timing so allows.

Timing Waveform of Flow-Through Read-to-Write-to-Read ( $\overline{OE} = VIL$ )<sup>(2)</sup>



Timing Waveform of Flow-Through Read-to-Write-to-Read (**OE** Controlled)<sup>(2)</sup>



#### NOTES:

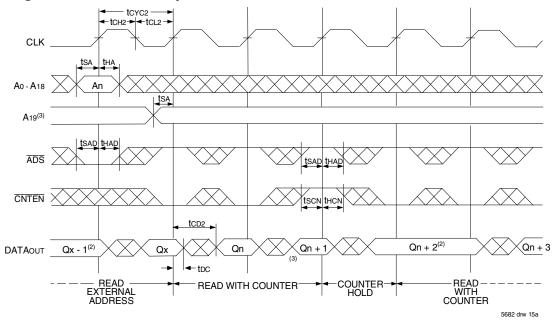
1. Output state (High, Low, or High-impedance) is determined by the previous cycle control signals.

2. TEO, BEn, and ADS = VIL; CE1, TONTEN, and REPEAT = VIH.

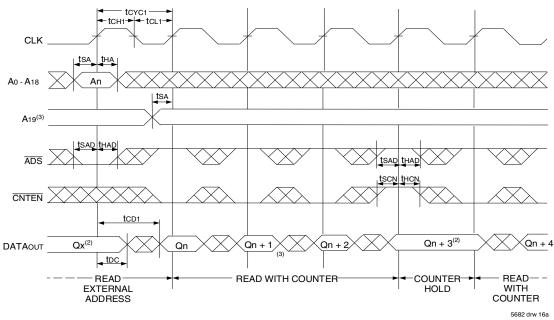
3. Addresses do not have to be accessed sequentially since ADS = VIL constantly loads the address on the rising edge of the CLK; numbers are for reference use only.

4. "NOP" is "No Operation." Data in memory at the selected address may be corrupted and should be re-written to guarantee data integrity.

Timing Waveform of Pipelined Read with Address Counter Advance<sup>(1)</sup>

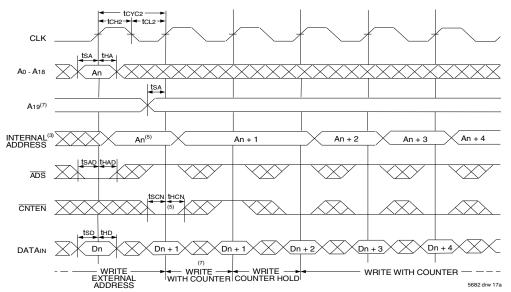


## Timing Waveform of Flow-Through Read with Address Counter Advance<sup>(1)</sup>

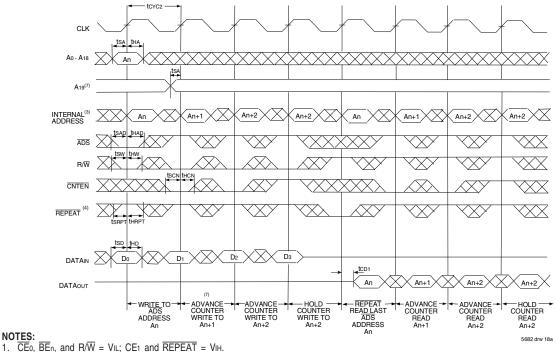


- 1.  $\overline{CE}_{0}$ ,  $\overline{OE}$ ,  $\overline{BE}_{n}$  = VIL; CE1, R/W, and  $\overline{REPEAT}$  = VIH.
- 2. If there is no address change via  $\overline{ADS} = VIL$  (loading a new address) or  $\overline{CNTEN} = VIL$  (advancing the address), i.e.  $\overline{ADS} = VIH$  and  $\overline{CNTEN} = VIH$ , then the data remains constant for subsequent clocks.
- 3. Address A19 must be managed as part of a full depth counter implementation using the IDT70T3509M. For physical addresses 00000H through 7FFFFH the value of a A19 is 0, while for physical addresses 80000H through FFFFH the value of A19 is 1. The user needs to keep track of the device counter and make sure that A19 is actively driven from 0-to-1 or 1-to-0 and held as needed at the appropriate address boundaries for full depth counter operation. As shown this transition reflects An = 7FFFFH or FFFFFH.

## **Timing Waveform of Write with Address Counter Advance** (Flow-through or Pipelined Inputs)<sup>(1)</sup>



## Timing Waveform of Counter Repeat<sup>(2,6)</sup>

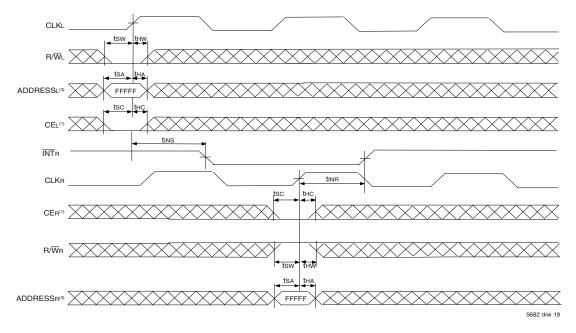


## 2. $\overline{CE}_{0}$ , $\overline{BE}_{n} = VIL$ ; $CE_{1} = VIH$ .

- 3. The "Internal Address" is equal to the "External Address" when ADS = VIL and equals the counter output when ADS = VIH.
- 4. No dead cycle exists during REPEAT operation. A READ or WRITE cycle may be coincidental with the counter REPEAT cycle: Address loaded by last valid ADS load will be accessed. For more information on REPEAT function refer to Truth Table II. A19 must be in the appropriate state when using the REPEAT function to guarantee the correct address location is loaded.
- 5. CNTEN = VIL advances Internal Address from 'An' to 'An +1'. The transition shown indicates the time required for the counter to advance. The 'An +1'Address is written to during this cycle.
- 6. For Pipelined Mode user should add 1 cycle latency for outputs as per timing waveform of read cycle for pipelined operations.
- 7. Address A19 must be managed as part of a full depth counter implementation using the IDT70T3509M. For physical addresses 00000H through 7FFFH the value of a A19 is 0, while for physical addresses 80000H through FFFFH the value of A19 is 1. The user needs to keep track of the device counter and make sure that A19 is actively driven from 0-to-1 or 1-to-0 and held as needed at the appropriate address boundaries for full depth counter operation. As shown this transition reflects An = 7FFFFH or FFFFFH.

5682 tbl 12

## Waveform of Interrupt Timing<sup>(2)</sup>



#### NOTES:

- 1.  $\overline{CE}_0 = V_{IL}$  and  $CE_1 = V_{IH}$ .
- 2. All timing is the same for Left and Right ports.

3. Address is for internal register, not the external bus, i.e. address needs to be qualified by one of the Address counter control signals.

| Left Port |                             |                            |          |      | Right Port |                             |                    |          |      |                       |
|-----------|-----------------------------|----------------------------|----------|------|------------|-----------------------------|--------------------|----------|------|-----------------------|
| CLK∟      | <b>R/₩</b> L <sup>(2)</sup> | <b>CE</b> L <sup>(2)</sup> | A19L-A0L | ĪNT∟ | CLKR       | <b>R/W</b> R <sup>(2)</sup> | CER <sup>(2)</sup> | A19R-A0R | ĪNTR | Function              |
| ↑         | L                           | L                          | FFFFF    | Х    | Ŷ          | Х                           | Х                  | Х        | L    | Set Right INTR Flag   |
| ↑         | Х                           | Х                          | Х        | Х    | Ŷ          | Н                           | L                  | FFFFF    | Н    | Reset Right INTR Flag |
| ↑         | х                           | Х                          | Х        | L    | Ŷ          | L                           | L                  | FFFFE    | х    | Set Left INTL Flag    |
| Ŷ         | Н                           | L                          | FFFFE    | Н    | $\uparrow$ | Х                           | Х                  | Х        | Х    | Reset Left INTL Flag  |

## Truth Table III - Interrupt Flag<sup>(1)</sup>

#### NOTES:

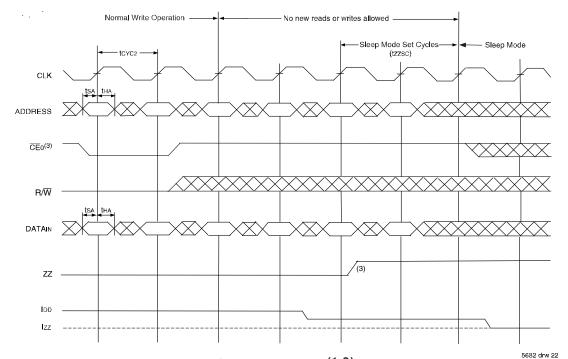
1. INTL and INTR must be initialized at power-up by Resetting the flags.

2. CE0 = VIL and CE1 = VIH, RW and CE are synchronous with respect to the clock and need valid set-up and hold times.

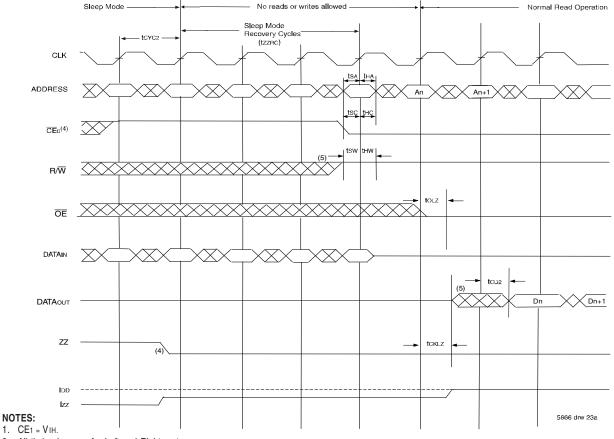
3. Address is for internal register, not the external bus, i.e. address needs to be qualified by one of the Address counter control signals.

High-Speed 2.5V 1024K x 36 Dual-Port Synchronous Static RAM

## Timing Waveform - Entering Sleep Mode (1,2)



Timing Waveform - Exiting Sleep Mode (1,2)



2. All timing is same for Left and Right ports.

3.  $\overline{CE}_0$  has to be deactivated ( $\overline{CE}_0 = V_{IH}$ ) three cycles prior to asserting ZZ (ZZx = V\_{IH}) and held for two cycles after asserting ZZ (ZZx = V\_{IH}).

4. CE<sub>0</sub> has to be deactivated (CE<sub>0</sub> = VIH) one cycle prior to de-asserting ZZ (ZZx = VIL) and held for three cycles after de-asserting ZZ (ZZx = VIL).

<sup>5.</sup> The device must be in Read Mode (R/W High) when exiting sleep mode. Outputs are active but data is not valid until the following cycle.

#### IDT70T3509M

#### High-Speed 2.5V 1024K x 36 Dual-Port Synchronous Static RAM

## **Functional Description**

The IDT70T3509M provides a true synchronous Dual-Port Static RAM interface. Registered inputs provide minimal set-up and hold times on address, data, and all critical control inputs. All internal registers are clocked on the rising edge of the clock signal, however, the self-timed internal write pulse width is independent of the cycle time.

An asynchronous output enable is provided to ease asynchronous bus interfacing. Counterenable inputs are also provided to stall the operation of the address counters for fast interleaved memory applications.

The combination of a HIGH on  $\overline{CE}_0$  and a LOW on CE1 for one clock cycle will power down the internal circuitry to reduce static power consumption. Multiple chip enables allow easier banking of multiple IDT70T3509Ms for depth expansion configurations. Two cycles are required with  $\overline{CE}_0$  LOW and CE1 HIGH to re-activate the outputs.

## Width Expansion

The IDT70T3509M can be used in applications requiring expanded width. Through combining the control signals, the devices can be grouped as necessary to accommodate applications needing 72-bits or wider.

## **Sleep Mode**

The IDT70T3509M is equipped with an optional sleep or low power mode on both ports. The sleep mode pin on both ports is asynchronous and active high. During normal operation, the ZZ pin is pulled low. When ZZ is pulled high, the port will enter sleep mode where it will meet lowest possible power conditions. The sleep mode timing diagram shows the modes of operation: Normal Operation, No Read/Write Allowed and Sleep Mode.

For normal operation all inputs must meet setup and hold times prior to sleep and after recovering from sleep. Clocks must also meet cycle high and low times during these periods. Three cycles prior to asserting ZZ (ZZx = VIH) and three cycles after de-asserting ZZ (ZZx = VIH), the device must be disabled via the chip enable pins. If a write or read operation occurs during these periods, the memory array may be corrupted. Validity of data out from the RAM cannot be guaranteed immediately after ZZ is asserted (prior to being in sleep). When exiting sleep mode, the device must be in Read mode (R/Wx = VIH) when chip enable is asserted, and the chip enable must be valid for one full cycle before a read will result in the output of valid data.

During sleep mode the RAM automatically deselects itself. The RAM disconnects its internal clock buffer. The external clock may continue to run without impacting the RAMs sleep current (Izz). All outputs will remain in high-Z state while in sleep mode. All inputs are allowed to toggle. The RAM will not be selected and will not perform any reads or writes.

#### IDT70T3509M High-Speed 2.5V 1024K x 36 Dual-Port Synchronous Static RAM

## **JTAG Functionality and Configuration**

The IDT70T3509M is composed of four independent memory arrays, and thus cannot be treated as a single JTAG device in the scan chain. The four arrays (A, B, C and D) each have identical characteristics and commands but must be treated as separate entities in JTAG operations. Please refer to Figure 2.

JTAG signaling must be provided serially to each array and utilize the information provided in the Identification Register Definitions, Scan

Register Sizes, and System Interface Parameter tables. Specifically, all serial commands must be issued to the IDT70T3509M in the following sequence: Array D, Array C, Array B, Array A. Please reference Application Note AN-411, "JTAG Testing of Multichip Modules" for specific instructions on performing JTAG testing on the IDT70T3509M. AN-411 is available at www.idt.com.

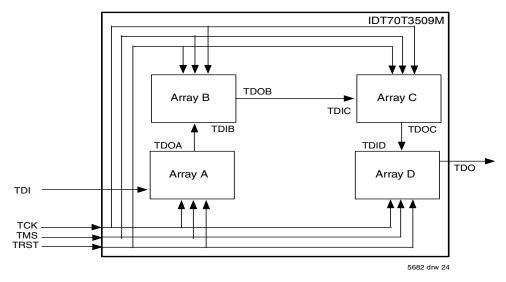
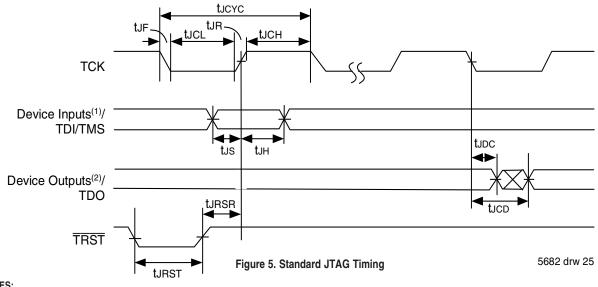


Figure 2. JTAG Configuration for IDT70T3509M

## **JTAG Timing Specifications**



NOTES:

1. Device inputs = All device inputs except TDI, TMS, and TRST.

2. Device outputs = All device outputs except TDO.

|               |                         | 70T3509M |                  |       |  |  |
|---------------|-------------------------|----------|------------------|-------|--|--|
| Symbol        | Parameter               | Min.     | Max.             | Units |  |  |
| tucyc         | JTAG Clock Input Period | 100      |                  | ns    |  |  |
| tjcн          | JTAG Clock HIGH         | 40       |                  | ns    |  |  |
| tJCL          | JTAG Clock Low          | 40       |                  | ns    |  |  |
| tır           | JTAG Clock Rise Time    |          | 3(1)             | ns    |  |  |
| IJF           | JTAG Clock Fall Time    |          | 3 <sup>(1)</sup> | ns    |  |  |
| <b>t</b> JRST | JTAG Reset              | 50       |                  | ns    |  |  |
| <b>t</b> JRSR | JTAG Reset Recovery     | 50       |                  | ns    |  |  |
| tJCD          | JTAG Data Output        |          | 25               | ns    |  |  |
| tJDC          | JTAG Data Output Hold   | 0        |                  | ns    |  |  |
| tus           | JTAG Setup              | 15       |                  | ns    |  |  |
| IJН           | JTAG Hold               | 15       |                  | ns    |  |  |

## JTAG AC Electrical Characteristics <sup>(1,2,3,4)</sup>

#### NOTES:

1. Guaranteed by design.

2. 30pF loading on external output signals.

3. Refer to AC Electrical Test Conditions stated earlier in this document.

 JTAG operations occur at one speed (10MHz). The base device may run at any speed specified in this datasheet.

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IDT70T3509M High-Speed 2.5V 1024K x 36 Dual-Port Synchronous Static RAM

**Commercial Temperature Range** 

## **Identification Register Definitions**

| Instruction Field Array D         | Value<br>Array D | Instruction Field Array C          | Value<br>Array C | Instruction Field Array B          | Value<br>Array B | Instruction Field Array A          | Value<br>Array A | Description  |
|-----------------------------------|------------------|------------------------------------|------------------|------------------------------------|------------------|------------------------------------|------------------|--|
| Revision Number (31:28)           | 0x0              | Revision Number (63:60)            | 0x0              | Revision Number (95:92)            | 0x0              | Revision Number (127:124)          | 0x0              | Reserved for Version number                          |
| IDT Device ID (27:12)             | 0x333            | IDT Device ID (59:44)              | 0x333            | IDT Device ID (91:76)              | 0x333            | IDT Device ID (123:108)            | 0x333            | Defines IDT Part number                              |
| IDT JEDEC ID (11:1)               | 0x33             | IDT JEDEC ID (43:33)               | 0x33             | IDT JEDEC ID (75:65)               | 0x33             | IDT JEDEC ID (107:97)              | 0x33             | Allows unique identification of device vendor as IDT |
| ID Register Indicator Bit (Bit 0) | 1                | ID Register Indicator Bit (Bit 32) | 1                | ID Register Indicator Bit (Bit 64) | 1                | ID Register Indicator Bit (Bit 96) | 1                | Indicates the presence of an ID Register             |

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5682 tbl 18

## **Scan Register Sizes**

| Register Name        | Bit Size<br>Array A | Bit Size<br>Array B | Bit Size<br>Array C | Bit Size<br>Array D | Bit Size<br>70T3509M |
|----------------------|---------------------|---------------------|---------------------|---------------------|----------------------|
| Instruction (IR)     | 4                   | 4                   | 4                   | 4                   | 16                   |
| Bypass (BYR)         | 1                   | 1                   | 1                   | 1                   | 4                    |
| Identification (IDR) | 32                  | 32                  | 32                  | 32                  | 128                  |
| Boundary Scan (BSR)  | Note (3)             |

5682 tbl 17

## **System Interface Parameters**

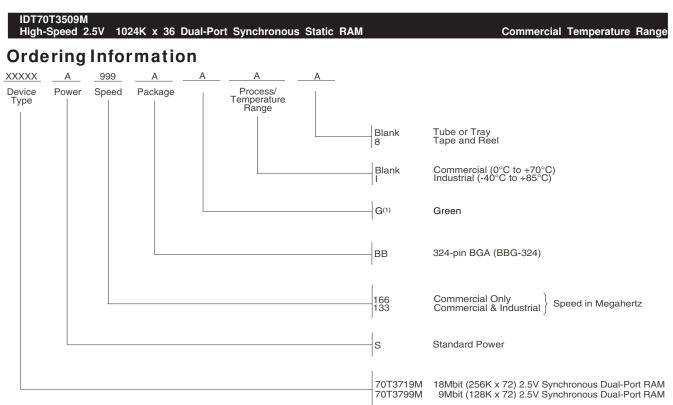
| Instruction    | Code   | Description   |  |  |
|----------------|--|---|--|--|
| EXTEST         | 000000000000000000000000000000000000000  | Forces contents of the boundary scan cells onto the device outputs <sup>(1)</sup> . Places the boundary scan register (BSR) between TDI and TDO.  |  |  |
| BYPASS         | 11111111111111   | Places the bypass register (BYR) between TDI and TDO.   |  |  |
| IDCODE         | 0010001000100010   | Loads the ID register (IDR) with the vendor ID code and places the register between TDI and TDO.  |  |  |
| HIGHZ          | 0100010001000100   | Places the bypass register (BYR) between TDI and TDO. Forces all device output drivers except INTx to a High-Z state.   |  |  |
| CLAMP          | 0011001100110011   | Uses BYR. Forces contents of the boundary scan cells onto the device outputs. Places the bypass register (BYR) between TDI and TDO.   |  |  |
| SAMPLE/PRELOAD | 0001000100010001   | Places the boundary scan register (BSR) between TDI and TDO.<br>SAMPLE allows data from device inputs <sup>(2)</sup> to be captured in the<br>boundary scan cells and shifted serially through TDO. PRELOAD allows<br>data to be input serially into the boundary scan cells via the TDI. |  |  |
| RESERVED       | 0101010101010101, 0111011101110111,<br>1000100010001000, 1001100110011001,<br>101010101010101, 101110111011,<br>1100110011001100 | Several combinations are reserved. Do not use codes other than those identified above.  |  |  |
| PRIVATE        | 0110011001100110, 1110111011101110, 11011101   | For internal use only.  |  |  |

#### NOTES:

1. Device outputs = All device outputs except TDO.

2. Device inputs = All device inputs except TDI, TMS, and  $\overline{\text{TRST}}$ .

3. The Boundary Scan Descriptive Language (BSDL) file for this device is available on the IDT website (www.idt.com), or by contacting your local IDT sales representative.



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#### NOTES:

- 1. Contact your local sales office for Industrial temp range in other speeds, packages and powers.
- 2. Green parts available. For specific speeds, packages and powers contact your local sales office.
- 3. BP-256 package thickness is 1.76mm nominal. This is thicker than the BC-256 package (1.40mm nominal) used for the lower density IDT dual-port products.

## **Datasheet Document History:**

| 11/09/04:<br>03/24/05: | Initial Public Release of Preliminary Datasheet<br>Page 1 Added I-temp offering to features                         |
|------------------------|---|
|                        | Page 6 Added I-temp information to the Recommended Operating Temperature and Supply Voltage table                   |
|                        | Page 8 Added I-temp values to the DC Electrical Characteristics table   |
|                        | Page 10 Added I-temp to the heading of the AC Electrical Characteristics table                                      |
|                        | Page 23 Added I-temp to ordering information  |
|                        | Page 1 Added green availability to features   |
|                        | Page 1 - 23 Removed Preliminary status  |
| 06/14/05:              | Page 1 Added feature to highlight footprint compatibility   |
|                        | Page 3 & 23 Added a footnote to highlight package thickness of BP-256 vs. BC-256                                    |
| 08/27/07:              | Page 1 Functional Block Diagram changed to correct chip enable logic and added footnote 2 referencing Truth Table I |
| 07/28/08:              | Page 8 Corrected a typo in the DC Chars table   |
| 01/19/09:              | Page 23 Removed "IDT" from orderable part number  |
| 07/15/14:              | Page 23 Added Tape & Reel to Ordering Information   |



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